

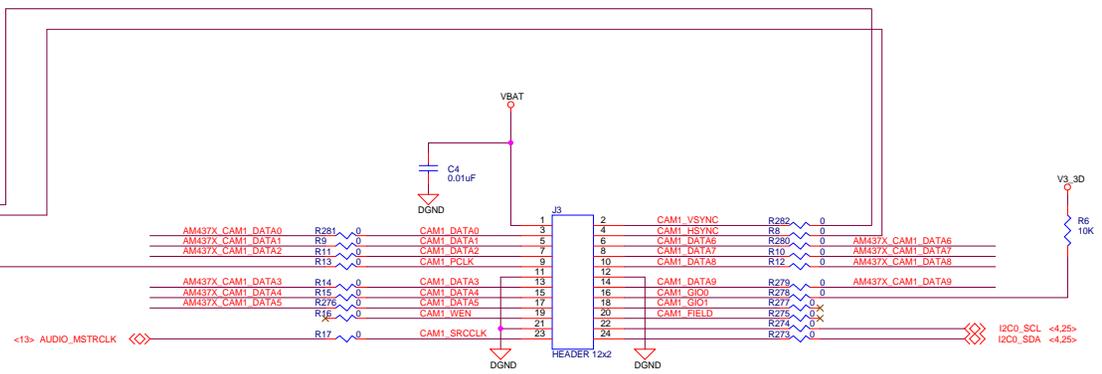
These components are not needed for Camera

U99-17

AM437X CAMERA1  
GP EVM

CAM1_PCLK	AE21	AM437X	CAM1_PCLK
CAM1_VSYNC	AC23	AM437X	CAM1_VSYNC
CAM1_HSYNC	AD25	AM437X	CAM1_HSYNC
CAM1_DATA0	AB20	AM437X	CAM1_DATA0
CAM1_DATA1	AC21	AM437X	CAM1_DATA1
CAM1_DATA2	AD21	AM437X	CAM1_DATA2
CAM1_DATA3	AE22	AM437X	CAM1_DATA3
CAM1_DATA4	AD22	AM437X	CAM1_DATA4
CAM1_DATA5	AE23	AM437X	CAM1_DATA5
CAM1_DATA6	AD23	AM437X	CAM1_DATA6
CAM1_DATA7	AE24	AM437X	CAM1_DATA7
CAM1_DATA8	AD24	AM437X	CAM1_DATA8
CAM1_DATA9	AC24	AM437X	CAM1_DATA9

AM437X\_ZDN



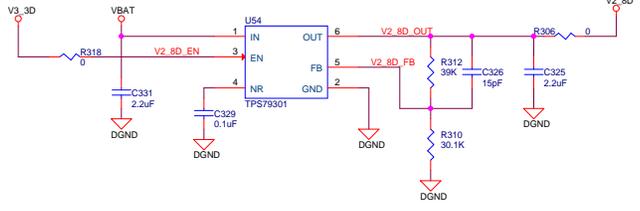
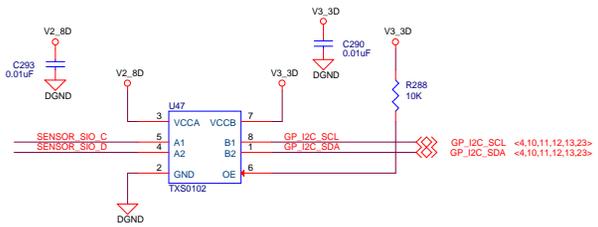
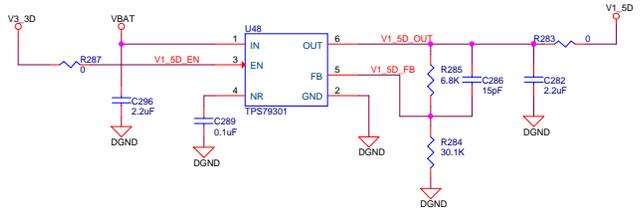
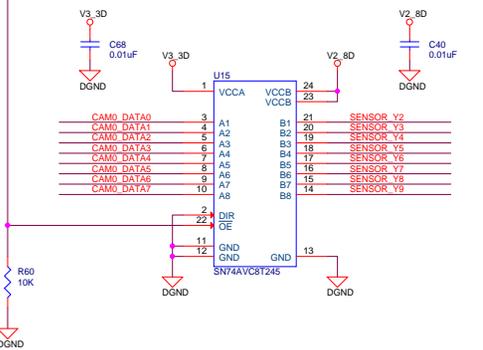
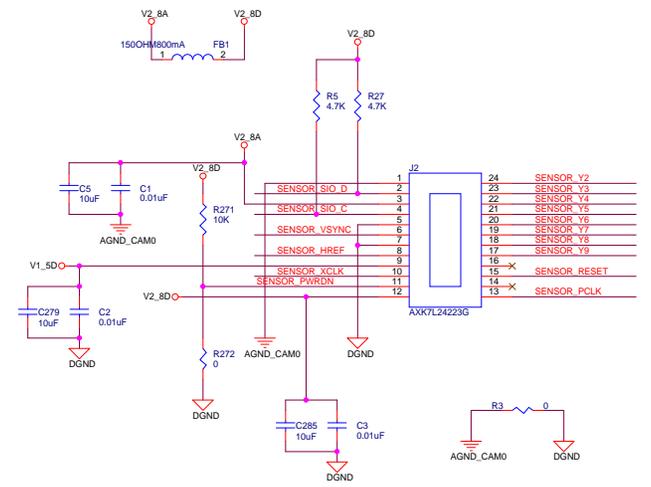
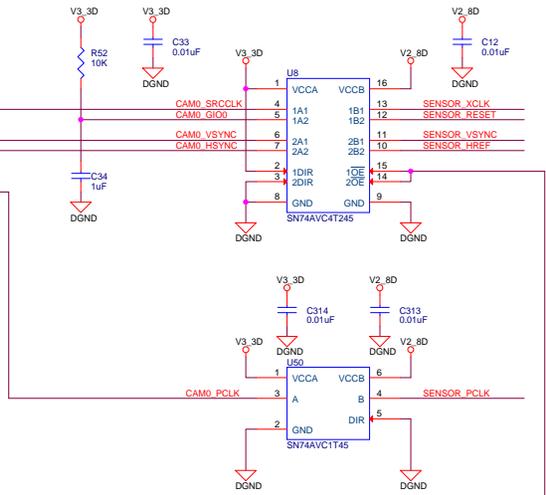
PCB2  
Camera Board Assembled PCB

<b>ARM MPU</b>	<b>Texas Instruments, Inc.</b>			
	ARM MPU Business Unit 12500 TI Blvd Dallas, TX 75243			
	<b>AM437x General Purpose EVM</b>			
	Camera #0			
Size	Document Number	Modified By:	Rev	
C	am437x_gp_evm_3k0006_rev1_4a.dsn	Damon Domke	1.4A	
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U59-16

CAM0_PCLK	AC20	AM437X CAM0_PCLK	R105	0	
CAM0_VSYNC	AD18	AM437X CAM0_VSYNC	R334	0	
CAM0_HSYNC	AE17	AM437X CAM0_HSYNC	R329	0	
CAM0_DATA0	AE18	AM437X CAM0_DATA0	R336	0	CAM0_DATA0
CAM0_DATA1	AB18	AM437X CAM0_DATA1	R100	0	CAM0_DATA1
CAM0_DATA2	Y18	AM437X CAM0_DATA2	R105	0	CAM0_DATA2
CAM0_DATA3	AA18	AM437X CAM0_DATA3	R101	0	CAM0_DATA3
CAM0_DATA4	AE19	AM437X CAM0_DATA4	R340	0	CAM0_DATA4
CAM0_DATA5	AD19	AM437X CAM0_DATA5	R339	0	CAM0_DATA5
CAM0_DATA6	AE20	AM437X CAM0_DATA6	R348	0	CAM0_DATA6
CAM0_DATA7	AD20	AM437X CAM0_DATA7	R345	0	CAM0_DATA7
CAM0_DATA8	AB19	AM437X CAM0_DATA8	TP1m	TP19	
CAM0_DATA9	AA19	AM437X CAM0_DATA9	TP1m	TP18	

AM437X\_ZDN



**ARM MPU** Texas Instruments, Inc.

ARM MPU Business Unit  
12500 TI Blvd  
Dallas, TX 75243

**AM437x General Purpose EVM**  
Camera #1

Size	Document Number	Modified By:	Rev
C	am437x_gp_evm_3k0006_rev1_4a.dsn	Damon Domke	1.4A

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